



D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

08.2019

Micro OLED 0.95" - 96x64 dots

Incl. controller SSD1305Z







Features

- 0.95" Low-Power OLED
- -40..+80°C (T_{op.})
- 96x64 dots
- Incl. controller SSD1305Z
- SPI, I2C, 8-Bit Interface
- Fast response time (10µs) even at -40°C

Ordering code

OLED 0.95" - 96x64 dots, yellow

EA W096064-XALG





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1. General Specification

2.1. Item	Dimension	Unit
Dot Matrix	96 x 64 Dots	_
Module dimension	24.9 × 22.95 × 1.65 (mm)	mm
Active Area	19.946 × 13.418 (mm)	mm
Pixel Size	0.186 × 0.188 (mm)	mm
Pixel Pitch	0.208 × 0.21 (mm)	mm
Display Mode	Passive Matrix	1
Display Color	Yellow	
Drive Duty	1/64 Duty	
IC	SSD1305Z	





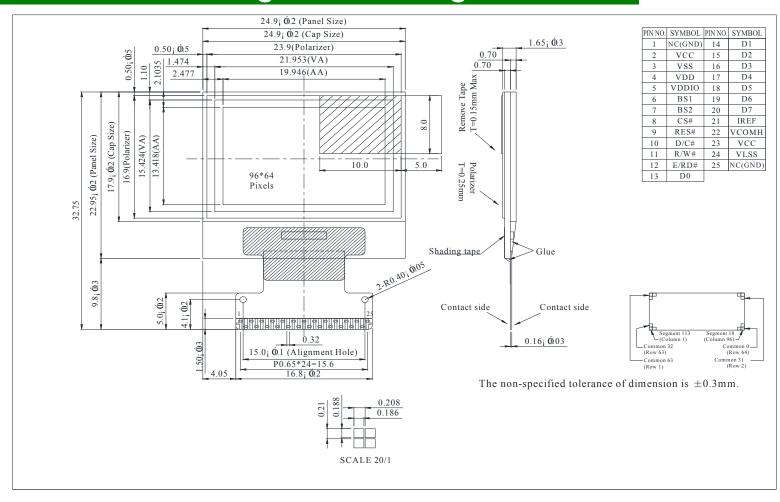
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2. Contour Drawing & Block Diagram







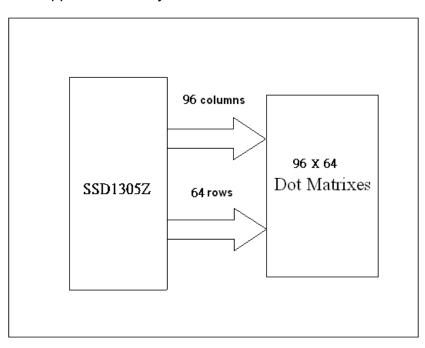
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VCC Supplied Externally







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3. Interface Pin Function

Pin Number	Symbol	I/O	Function				
1.	N.C. (GND)	-	Reserved Pin(Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.				
2.	VCC	P	Power Supply for OLED Panel This is the most positive voltage supply pin of the chip.It must be supplied externally.				
3.	VSS	P	Ground of Logic Circuit This is a ground pin. It also acts as a reference for the logic pins. It must be connected to external ground.				
4.	VDD	P	Power Supply for Logic Circuit This is a voltage supply pin. It must be connected to external source.				
5.	VDDIO	P	Power supply for interface logic level. It should be match with MCU interface voltage level. VDDIO must always be equal or lower than VDD.				
6.	BS1 BS2	I	Communicating Protocol Select These pins are MCU interface selection input. See the following table: 68XX-parallel 80XX-parallel Serial I2C				
7.	D52		BS1 0 1 0 1 BS2 1 1 0 0				
8.	CS#	I	Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.				
9.	RES#	I	Power Reset for Controller and Driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.				
10.	D/C#	I	Data/ Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at SDIN will be transferred to the command register. In I2C mode, this pin acts as SA0 for slave address selection.				
11.	R/W#	I	Read/ Write Selector Write				





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			This pin is MCU interface input. When interfacing to a68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XXinterface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low. Read/Write Enable or Read This pin is MCU interface input. When interfacing to a68XX series.
12.	E/RD#	I	This pin is MCU interface input. When interfacing to a68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
13.			
14.			Host Data In put/ Output Bus
15.		I/O	These pins are 8-bit bi-directional data bus to be connected to the
16.			microprocessor's data bus. When serial mode is selected. D1 will be the
17.	D0~D7		
18.	1		I2Cmode is selected, D2 & D1 should be tired together and serve as
19.	1		SDAout & SDAin in application and D0 is the serial clock input SCL.
20.			
21.	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10µA.
22.	VCOMH	О	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
23.	VCC	P	Power Supply for OLED Panel This is the most positive voltage supply pin of the chip.It must be supplied externally.
24.	VLSS	P	Ground of Analog Circuit This is an analog ground pin. It should be connected to VSS externally.
25.	N.C. (GND)	-	Reserved Pin(Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.





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4. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	1, 2
Supply Voltage for Display	VCC	0	15	V	1, 2
Operating Temperature	TOP	-40	+80	°C	-
Storage Temperature	TSTG	-40	+80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate





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5. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	11	12	13	V
Input High Volt.	VIH	_	0.8×VDD	_	VDDIO	V
Input Low Volt.	VIL	_	0	_	0.2×VDD	V
Output High Volt.	VOH	_	0.9×VDD	_	VDDIO	V
Output Low Volt.	VOL	_	0	_	0.1×VDD	V
50% Check Board operating Current	ICC	VCC=12V	5.8	6.0	7.5	mA





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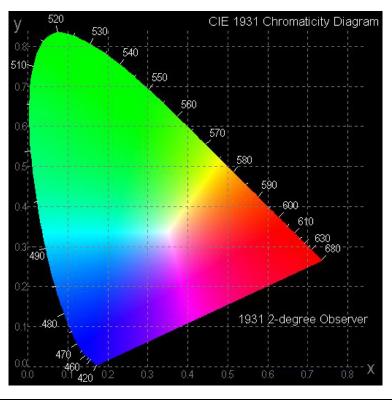
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6. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Annie	(V)θ		160			deg
View Angle	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1			
D T	T rise	_		10		μs
Response Time	T fall	_		10		μs
Display with 50% check	Display with 50% check Board Brightness			100		cd/m2
CIEx(Yellow)	(CIE1931)	0.45	0.47	0.49		
CIEy(Yellow)	(CIE1931)	0.48	0.50	0.52		







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7. OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value	50,000 Hrs	_	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.





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8. Reliability

Content of Reliability Test

Environmental Test						
Test Item	Content of Test	Test Condition	Applicable Standard			
High Temperature	Endurance test applying the high storage	80□				
storage	temperature for a long time.	240hrs				
Low Temperature	Endurance test applying the low storage	-40□				
storage	temperature for a long time.	240hrs				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80□ 240hrs				
Low Temperature	Endurance test applying the electric stress	-40□				
Operation	under low temperature for a long time.	240hrs				
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60□,90%RH 240hrs	_			
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40 \(\text{25} \) 30min 5min 30min 1 cycle	-40□/80□ 100 cycles				
Mechanical Test						
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr				
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction				
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs				
Others			•			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times				

^{***} Supply voltage for OLED system =Operating voltage at 25 $^{\circ}\!\mathbb{C}$





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Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.





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9. Inspection specification

NO	Item	Criterion					
01	Electrical	•	tical, ho	rizor	ntal segment,	segment contrast	
	Testing	defect.					
		1.2 Missing cha			or icon.		
		1.3 Display mal					0.65
			.4 No function or no display..5 Current consumption exceeds product specifications.				
			.6 OLED viewing angle defect.				
		1.7 Mixed produ					
		1.8 Contrast de	fect.				
02	Black or white					25mm, no more	
	spots on	than three white			•		2.5
	OLED	• •	aced: No	o mo	ore than two s	pots or lines within	
03	(display only) OLED black	3mm. 3.1 Round type	· A c				
03	spots, white	following drawing		Ī	SIZE	Acceptable Q	
	spots,	$\Phi = (x + y) / 2$	·9		0.22	TY	
	contamination	`x´´,	ı	-	Ф≦0.10	Accept no	
	(non-display)	→ → → · · · · · · · · · · · · · · · · ·	,			dense	
			_ _ Y		0.10 <	2	2.5
		_ 7	F .		Ф≦0.20		
			La		0.20 <	1	
					Ф≦0.25		
					0.25<Ф	0	
		3.2 Line type : (
		<u> L</u>	ength	Wid		Acceptable Q TY	
		<u> </u>	-		≦0.02	Accept no dense	2.5
		'' ''	≦3.0		2 <w≦0.03< td=""><td>2</td><td>2.5</td></w≦0.03<>	2	2.5
		<u> L</u>	≦2.5		3 <w≦0.05< td=""><td></td><td></td></w≦0.05<>		
			-	0.0	5 <w< td=""><td>As round type</td><td></td></w<>	As round type	
04	Polarizer						
	bubbles	If bubbles are v		Siz	е Ф	Acceptable Q TY	
		judge using bla			≦0.20	Accept no dense	
		spot specification		0.2	20<Ф≦0.50	3	2.5
		not easy to find check in specify		0.5	50<Φ≦1.00	2	
		direction.	y	1.0	Ф>00	0	
				Tot	al Q TY	3	





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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED bl	lack spots, white spot	s, contamination	
			v: Chip width z: C : Glass thickness a: th:		
		6.1 General glass chi 6.1.1 Chip on panel s	•	ween panels:	
06	Chipped	z: Chip thickness Z≦1/2t	y: Chip width Not over viewing area	x: Chip length x≤1/8a	2.5
	glass	1/2t <z≦2t< td=""><td>Not exceed 1/3k</td><td>x≦1/8a</td><td></td></z≦2t<>	Not exceed 1/3k	x≦1/8a	
		⊙If there are 2 or mo 6.1.2 Corner crack: z: Chip thickness Z≤1/2t 1/2t <z≤2t< td=""><td>y: Chip width Not over viewing area Not exceed 1/3k</td><td>x: Chip length x≤1/8a x≤1/8a</td><td></td></z≤2t<>	y: Chip width Not over viewing area Not exceed 1/3k	x: Chip length x≤1/8a x≤1/8a	
		⊙If there are 2 or mo	re criips, x is trie total	пенуш от еасп стір.	





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NO	Item	Criterion	AQL					
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:						
		y: Chip width x: Chip length z: Chip thickness						
		$y \le 0.5$ mm $x \le 1/8$ a $0 < z \le t$						
		6.2.2 Non-conductive portion:						
06	Glass crack	y 12 12 12 12 12 12 12 12 12 12 12 12 12	2.5					
		y: Chip width x: Chip length z: Chip						
		y: Chip width x: Chip length z: Chip thickness						
		$y \le L$ $x \le 1/8a$ $0 < z \le t$						
		⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO						
		must remain and be inspected according to electrode terminal specifications.						
		⊙ If the product will be heat sealed by the customer, the alignment						
		mark not be damaged.						
		6.2.3 Substrate protuberance and internal crack.						
		y: width x: length y≤1/3L x ≤ a						
		y ≤ 1/3L x ≤ a						

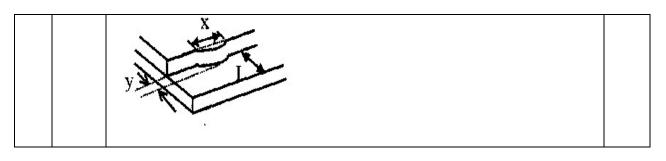




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NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	2.5 2.5 0.65 2.5 0.65 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65





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NO	Item	Criterion	AQL
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65





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Check Item	Classification	Criteria
No Display	Major	
Missing Line		
	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	





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			A Normal B Dark Pixel C Light Pixel	





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10. Precautions in use of OLED Modules

Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8)It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time
- (10)ELECTRONIC ASSEMBLY has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) ELECTRONIC ASSEMBLY have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, ELECTRONIC ASSEMBLY have the right to modify the version.)

10.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the





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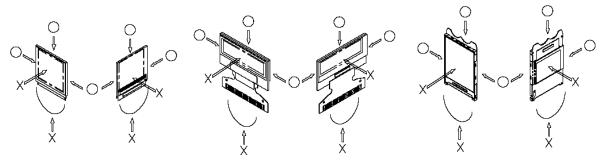
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System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protectivefilm.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

10.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from ELECTRONIC ASSEMBLY.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under





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high humidity environments, the electrodes may be corroded and be careful about the above.

10.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- * Connection (contact) to any other potential than the above may lead to rupture of the IC.

10.4. Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

10.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes
- * Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.



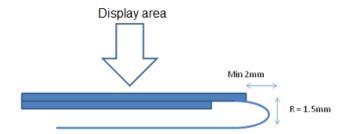


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- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)Our company will has the right to upgrade and modify the product function.
- (8) The limitation of FPC bending







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11. Initialization example

```
Global variables
uint8_t buf[20];
                      //SPI buffer
Function name: initW096064
Description: Initialization of the display
*********************************
void initW096064(void){
     uint16_t i = 0;
   PORT5.PODR.BIT.B5 = 0;
                              //Reset pin low
   ms_delay(100);
                          //100ms delay
   PORT5.PODR.BIT.B5 = 1;
                              //Reset pin high
   ms_delay(100);
                          //100ms delay
   buf[i++] = 0x40 + 0;
                         //set display start line to 0
   buf[i++] = 0xA6;
                         //set normal display mode
   buf[i++] = 0x81; buf[i++] = 0x7F; //Set contrast to 0x7F (default)
   buf[i++] = 0xD5; buf[i++] = 0x40; //clock divider/oscillator frequency
   buf[i++] = 0xD9; buf[i++] = 0x44; //pre-charge Period
   buf[i++] = 0xA1; //set segment remap (col. 131 to SEG0)
   buf[i++] = 0xC8; //set COM output scan direction (COM[n~1] to COM0)
   buf[i++] = 0xAF; //Display on
   waitforemptybuffer();
                         //Waits until SPI buffer is empty
   PORT5.PODR.BIT.B4 = 0;
                              //D/C# pin low
   R_RSPI0_Send(buf,i);
                          //send initialization buffer via SPI
}
```





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```
/***********************************
Function name: initWindow
Description: Initialization of the window in horizontal addressing mode
void initWindow(uint8_t startcol, uint8_t stopcol, uint8_t startpage, uint8_t stoppage){
     uint16 t i = 0;
   buf[i++] = 0x20;
                        //set memory addressing mode ...
   buf[i++] = 0x00;
                        //... to horizontal addressing mode
   buf[i++] = 0x21;
                        //set column address
   buf[i++] = 18+startcol; //start address
   buf[i++] = 18+stopcol;
                        //end address
   buf[i++] = 0x22;
                        //set page address
   buf[i++] = startpage;
                        //start page
   buf[i++] = stoppage;
                         //stop page
   waitforemptybuffer();
                        //waits until SPI buffer is empty
   PORT5.PODR.BIT.B4 = 0;
                        //set D/C# pin low
   R_RSPI0_Send(buf,i);
                         //send data buffer via SPI
}
/**********************************
Function name: sendDataW096064
Description: Sends data to the display (Initialization of the window before sending data to
the display -> initWindow()
**************************
void sendDataW096064(const uint8_t *tx_buf, uint16_t tx_num){
   PORT5.PODR.BIT.B4 = 1;
                               //D/C# pin high
   R_RSPI0_Send(tx_buf,tx_num);
                                //send data buffer
}
```





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12. Application example

SPI Interface

